KMY

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Specification

(Reference)

Title: FIXED CHIP RESISTOR NETWORKS; RECTANGULAR TYPE

Style: RAC10 2D,RAC10 4D,RAC16 4D, RAC16 8D

RoHS COMPLIANCE ITEM

Product specification contained in this specification are subject to change at any time without notice If you have any questions or a Purchasing Specification for any quality Agreement is necessary, please contact our sales staff.



Issue Dept.: Research & Development Department Hokkaido Research Center

Drawing No: RAC-K-HTS-0001

Title: FIXED CHIP RESISTOR NETWORKS; RECTANGULAR TYPE RAC10 2D, RAC10 4D, RAC16 4D, RAC16 8D

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1. Scope

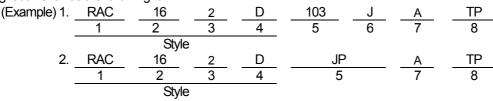
1.1 This specification covers the detail requirements for fixed chip resistors networks; rectangular type, style of RAC10 2D,10 4D,16 4D, 16 8D.

1.2 Applicable documents

JIS C 5201–1: 1998, JIS C 5201–9: 2006, JIS C 5201–9–1: 2006 IEC60115–1: 1999, IEC60115–9: 2003, IEC60115–9–1: 2003 EIAJ RC–2129–2000.

2. Classification

Type designation shall be the following form.



1 Fixed chip resistors networks; rectangular type

2 Size

3 Number of element

4 Circuits

5 Rated resistance Example; $103 \rightarrow 10$ k Ω , Chip jumper: JP

6 Tolerance on rated resistance

7 Terminal style

8 Packaging form 1. Scope

3. Rating

3.1 The ratings shall be in accordance with Table-1.

Table-1

Style

| Style | | Terminations style | Rated element dissipation (W) | Rated network dissipation (W) | Temperature coefficient of resistance (10 ⁻⁶ / °C) | Rated resistance range(Ω) | Preferred number series for resistors | Tolerance on rated resistance |
|-------|----------|-----------------------|--|--|--|---------------------------|---------------------------------------|-------------------------------|
| RAC10 | 2D 4D | С | 0.063 | 0.125 | ±200 | 10~1.0M | E24 | J(±5%) |
| RAC16 | 4D | С | 0.063 | 0.25 | ±200 | 10~1.0M | E24 | F(±1%) J(±5%) |
| | 8D | С | 0.063 | 0.25 | ±200 | 10~1.0M | E24 | J(±5%) |

| Style |) | Limiting element voltage(V) | Isolation voltage(V) | Number of element | Circuit networks | Category temperature range(°C) |
|--------|----|-----------------------------|-------------------------|----------------------|---------------------|--------------------------------|
| RAC10 | 2D | 25 | 50 | 2 | D | |
| | 4D | | | 4 | J D | <i>–</i> 55∼+125 |
| RAC16 | 4D | 50 | 100 | 4 | (Independence type) | -55~±125 |
| 100010 | 8D | 25 | 100 | 8 | | |

Note. Rated current of chip jumper: 1(A)

Note. Resistance value of chip jumper: $50m\Omega$ max.

3.2 Climatic category

55/125/56 Lower category temperature –55 °C

Upper category temperature +125 °C

Duration of the damp heat, steady state test 56days

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3.3 Stability class

5% Limits for change of resistance:

-for long-term tests \pm (5%+0.1Ω) Chip jumper: 50 mΩ max. -for short-term tests \pm (1%+0.05Ω) Chip jumper: 50 mΩ max.

3.4 Derating

The derated values of dissipation (or current rating in case of chip jumper) at temperature in excess of 70 °C shall be as indicated by the following curve.

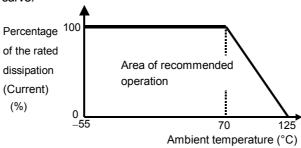


Figure-1Derating curve

3.5 Rated voltage

d. c. or a. c. r. m. s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

E : Rated voltage (V)

P : Rated dissipation (W)

R : Rated resistance (
$$\Omega$$
)

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

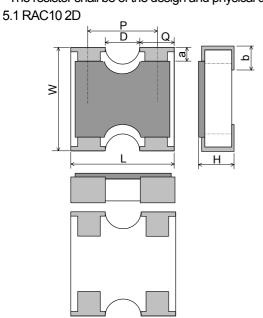
| Symbol | Packaging form | | Standard packaging quantity / units | Application |
|--------|----------------------|------------------------|--|----------------------------|
| В | Bulk (loose package) | | 1,000 pcs. | RAC10 2D, 4D, RAC16 4D, 8D |
| TH | Paper taping | 8mm width, 2mm pitches | 10,000 pcs. | RAC10 2D, 4D |
| TP | Paper taping | 8mm width, 4mm pitches | 5,000 pcs. | RAC16 4D, 8D |

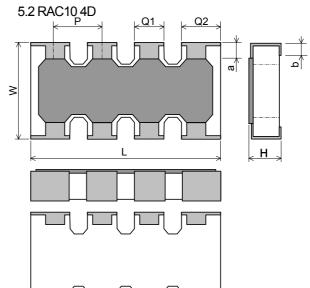
Title: FIXED CHIP RESISTOR NETWORKS; RECTANGULAR TYPE

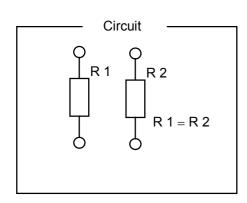
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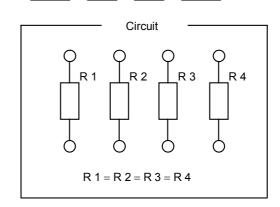
5. Dimensions

The resistor shall be of the design and physical dimensions in accordance with below.









Figure–2 Figure–3

Table–3 Unit: mm

| Style | Terminations style | Country of origin | L | W | Н | Q or Q₁ | $*Q_2$ |
|-----------|--------------------|-------------------|----------|----------|-----------|-----------|-----------|
| RAC10 2D | | Malaysia, | 1.0±0.05 | 1.0±0.05 | 0.35±0.05 | 0.33±0.10 | |
| RAC 10 2D | | China | 1.0±0.1 | 1.0±0.1 | 0.35±0.10 | 0.34±0.05 | |
| RAC104D | C | Malaysia, | 2.0±0.1 | 1.0±0.1 | 0.35±0.05 | 0.35±0.10 | 0.45±0.10 |
| | C | China | 2.0±0.1 | 1.0±0.1 | 0.45±0.10 | 0.3±0.05 | 0.4±0.1 |

| Style | Country of origin | D | а | b | *P | |
|-----------|-------------------|-----------|-----------|------------------|------|---|
| RAC10 2D | Malaysia, | 0.34±0.10 | 0.15±0.10 | 0.25 +0.05 -0.10 | 0.65 | 1 |
| TVACTO 2D | China | | 0.2±0.15 | 0.25±0.17 | 0.65 | |
| RAC10 4D | Malaysia, | | 0.15±0.10 | 0.25±0.10 | 0.5 | |
| NAC 10 4D | China | | 0.2±0.1 | 0.25±0.10 | 0.5 | |

*Reference

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5.3 RAC16 4D

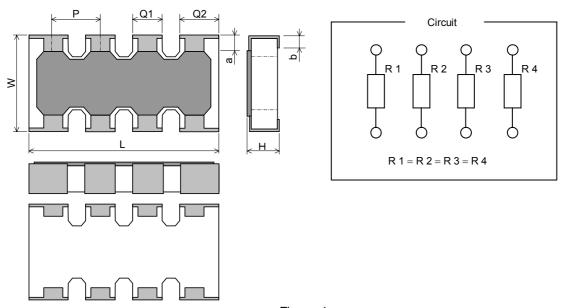


Figure 4

| | | | Table 4 | | | | Offic. ITHIT |
|----------|--------------------|-------------------|---------|---------|---------|----------------|--------------|
| Style | Terminations style | Country of origin | L | W | Н | Q ₁ | а |
| RAC16 4D | C | Malaysia, | 3.2±0.1 | 1.6±0.1 | 0.5±0.1 | 0.4±0.15 | 0.3±0.2 |
| 104D | | China | 3.2±0.1 | 1.6±0.1 | 0.5±0.1 | 0.4±0.1 | 0.3±0.1 |

| Style | Country of origin | b | *Q ₂ | *P |
|-----------|-------------------|-----------|-----------------|-----|
| RAC16 4D | Malaysia, | 0.25±0.15 | 0.6±0.15 | 0.8 |
| RAC 10 4D | China | 0.3±0.2 | 0.6±0.1 | 8.0 |

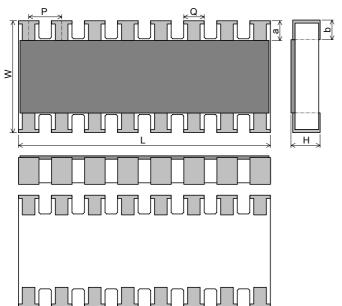
*Reference

Unit: mm

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5.4 RAC16 8D



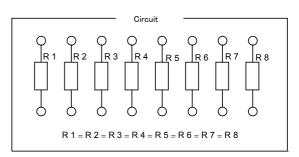


Figure-5

Table-5

Unit: mm

| Style | Terminations style | Country of origin | L | W | H | Q | а |
|---------|--------------------|-------------------|---------|---------|-----------|---------|---------|
| RAC168D | С | China | 3.8±0.1 | 1.6±0.1 | 0.45±0.10 | 0.3±0.1 | 0.3±0.1 |

*Reference

| Style Country of origin | | b | *P |
|-------------------------|-------|---------|---------|
| RAC168D | China | 0.3±0.1 | 0.5±0.1 |

5.2 Net weight (Reference)

| Style | Terminations style | Net weight(mg) |
|----------|--------------------|----------------|
| RAC10 2D | С | 1.1 |
| RAC104D | С | 2.1 |
| RAC164D | С | 7 |
| RAC16 8D | С | 8.3 |

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6. Marking

The Rated resistance of RAC10 2D should not be marked.

6.1 For the resistors

The rated resistance shall be marked in 3 digits (E24) and marked on over coat side.

| Marking | example | Contents | Application |
|----------|---------|--|-------------|
| Malaysia | China | Contents | Дрисацоп |
| 123 | 123 | $12\times10^3 \ [\Omega] \rightarrow 12 \ [k\Omega]$ | RAC104D |
| D123 | 123 | 12×10 ³ [Ω] → 12 [kΩ] | RAC164D |
| | 123 | 12×10 ³ [Ω] → 12 [kΩ] | RAC168D |

6.2 For the Jumper Chip

| Marking | example | Contents | Application | |
|----------|----------------|----------|-------------|--|
| Malaysia | Malaysia China | | Application | |
| | 000 | JP | RAC104D | |
| DO | 000 | JP | RAC164D | |
| | 000 | JP | RAC168D | |

7. Performance

- 7.1 The standard condition for tests shall be in accordance with Sub-clause 4. 2, JIS C 5201–1: 1998.
- 7.2 The performance shall be satisfied in Table-6.

Table-6(1)

| | | iable=0(1) | |
|-----|--------------------|---|--|
| No. | Test items | Condition of test (JIS C 5201–1) | Performance requirements |
| 1 | Visual examination | Sub-clause 4. 4. 1 Checked by visual examination. | As in 4. 4. 1 The marking shall be legible, as checked by visual examination. |
| 2 | Dimension | Sub-clause 4. 4. 2 | As specified in sub clause5.1 of this specification. |
| | Resistance | Sub-clause 4. 5 | As in 4. 5. 2 The resistance value shall correspond with the rated resistance taking into account the specified tolerance. Chip jumper: 50 mΩ max. |
| 3 | Voltage proof | Sub-clause 4. 7 Method: 4. 6. 1. 4(See Figure-8) Test voltage: Alternating voltage with a peak value of 1.42 times the insulation voltage. Duration: 60 s ± 5 s Insulation resistance Test voltage: Insulation voltage Duration: 1 min. | No breakdown or flash over $R \ge 1 \ G \ \Omega$ |
| 4 | Solderability | Sub-clause 4. 17 Without ageing Flux: The resistors shall be immersed in a non-activated soldering flux for 2s. Bath temperature: 235 °C ± 5 °C Immersion time: 2 s ± 0.5 s | As in 4. 17. 4. 5 The terminations shall be covered with a smooth and bright solder coating. |



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Table-6(2)

| No | Test items | Condition of test (JIS C 5201 - 1) | Performance requirements |
|----|---|---|--|
| 5 | Mounting | Sub-clause 4. 31 | |
| | | Substrate material: Epoxide woven glass | |
| | 0.004 | Test substrate: Figure–6 | |
| | Overload (in the manufact of atata) | Sub-clause 4. 13 | |
| | (in the mounted state) | The applied voltage shall be 2.5 times the | |
| | | rated voltage or twice the limiting element | |
| | | voltage, whichever is the less severe. | |
| | | Duration: 2 s Visual examination | No visible damage |
| | | Resistance | $\Delta R \le \pm (1\% + 0.05\Omega)$ |
| | | 1 Nesistat ice | Chip jumper: 50 m Ω max. |
| | Solvent resistance of the | Sub-clause 4. 30 | Legible marking |
| | marking | Solvent: 2–propanol | 3 |
| | | Solvent temperature: 23°C±5°C | |
| | | Method 1 | |
| | | Rubbing material: cotton wool | |
| | | Without recovery | |
| 6 | Mounting | Sub-clause 4. 31 | |
| | | Substrate material: Epoxide woven glass | |
| | | Test substrate: Figure–7 | |
| | Bound strength of the end | Sub-clause 4. 33 | |
| | face plating | Bent value: 3 mm | AD (1/40/ 10.050) |
| | | Resistance | $\Delta R \le \pm (1\% + 0.05\Omega)$ |
| | Final measurements | Out. stans 4 00 0 | Chip jumper: 50 mΩ max. No visible damage |
| | T I I I I I I I I I I I I I I I I I I I | Sub-clause 4. 33. 6 Visual examination | NO VISIBLE damage |
| 7 | Resistance to soldering heat | | |
| ′ | Resistance to soldering heat | Sub-clause 4. 18 Solder temperature: 260°C±5°C | |
| | | Immersion time: 10s±0.5s | |
| | | Visual examination | As in 4. 18. 3. 4 |
| | | Violati Ozarrii latori | No sign of damage such as cracks. |
| | | Resistance | $\Delta R \le \pm (1\% + 0.05\Omega)$ |
| | | | Chip jumper: $50 \text{ m}\Omega$ max. |
| | Component solvent | Sub-clause 4.29 | .,, |
| | resistance | Solvent: 2-propanol | |
| | | Solvent temperature: 23°C±5°C | |
| | | Method 2 | |
| | | Recovery: 48 h | |
| | | Visual examination | No visible damage |
| | | Resistance | $\Delta R \le \pm (1\% + 0.05\Omega)$ |
| | | | Chip jumper: $50 \mathrm{m}\Omega$ max. |



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Table-6(3)

| No | Test items | Condition of test (JIS C 5201 - 1) | Performance requirements |
|----|--------------------------|---|---|
| 8 | Mounting | Sub-clause 4. 31 | |
| | | Substrate material: Epoxide woven glass | |
| | | Test substrate: Figure-6 | |
| | Adhesion | Sub-clause 4. 32 | |
| | | Force: 5 N | |
| | | Duration: 10s±1s | No visible demons |
| | Rapid change temperature | Visual examination | No visible damage |
| | Rapid Change temperature | Sub-clause 4.19 | |
| | | Lower category temperature : -55 °C | |
| | | Upper category temperature : +125 °C | |
| | | Duration of exposure at each temperature: 30 | |
| | | min. | |
| | | Number of cycles: 5 cycles. Visual examination | No visible damage |
| | | Resistance | $\Delta R \le \pm (1\% + 0.05\Omega)$ |
| | | 1 Cesistal ICe | Chip jumper: 50 m Ω max. |
| 9 | Climatic sequence | Sub-clause 4. 23 | , , , |
| | -Dry heat | Sub-clause 4. 23. 2 | |
| | | Test temperature: +125 °C | |
| | | Duration: 16 h | |
| | –Damp heat, cycle | Sub-clause 4. 23. 3 | |
| | (12+12hour cycle) | Test method: 2 | |
| | First cycle | Test temperature: 55 °C | |
| | | [Severity(2)] | |
| | -Cold | Sub-clause 4. 23. 4 | |
| | | Test temperature–55 °C | |
| | | Duration: 2h | |
| | -Damp heat, cycle | Sub-clause 4. 23. 6 | |
| | (12+12hourcycle) | Test method: 2 | |
| | Remaining cycle | Test temperature: 55 °C | |
| | | [Severity (2)] | |
| | –D.C. load | Number of cycles: 5 cycles | |
| | -D.C. IOau | Sub-clause 4. 23. 7 | |
| | | The applied voltage shall be the rated voltage or the limiting element voltage whichever is | |
| | | the smaller. | |
| | | Duration: 1 min. | |
| | | Visual examination | No visible damage |
| | | Resistance | $\Delta R \le \pm (5\% + 0.1\Omega)$ |
| | | 1.00.000.100 | Chip jumper: $50 \mathrm{m}\Omega$ max. |



FIXED CHIP RESISTOR NETWORKS; RECTANGULAR TYPE Title: RAC10 2D, RAC10 4D, RAC16 4D, RAC16 8D

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Table-6(4)

| No | Test items | Condition of test (JIS C 5201 - 1) | Performance requirements |
|----|--|---|--|
| 10 | Mounting Endurance at 70 °C | Sub-clause 4. 31 Substrate material: Epoxide woven glass Test substrate: Figure–6 Sub-clause 4. 25. 1 Ambient temperature: 70°C±2°C Duration: 1000 h The voltage shall be applied in cycles of 1. 5 h on and 0. 5 h off. The applied voltage shall be the rated voltage or the limiting element voltage whichever is the smaller. Examination at 48 h , 500 h and | |
| | | 1000 h: Visual examination Resistance | No visible damage $\Delta R \le \pm (5\% + 0.1\Omega)$ Chip jumper: 50 m Ω max. |
| 11 | Mounting Variation of resistance with temperature | Sub-clause 4. 31 Substrate material: Epoxide woven glass Test substrate: Figure–6 Sub-clause 4. 8 –55 °C / +20 °C +20 °C / +125°C | As in Table–1 |
| 12 | Mounting Damp heat, steady state | Sub-clause 4. 31 Substrate material: Epoxide woven glass Test substrate: Figure–6 Sub-clause 4. 24 Ambient temperature: 40°C±2°C Relative humidity: 93 +2/3 % a) 1st group: without voltage applied. b) 2nd group: The d. c. voltage shall be applied continuously. The voltage shall be accordance with Sub-clause 4. 24. 2.1 b). without polarizing voltage [4. 24. 2. 1, c)] Visual examination Resistance | No visible damage Legible marking $\Delta R \le \pm (5\%+0.1\Omega)$ Chip jumper: 50 m Ω max. |

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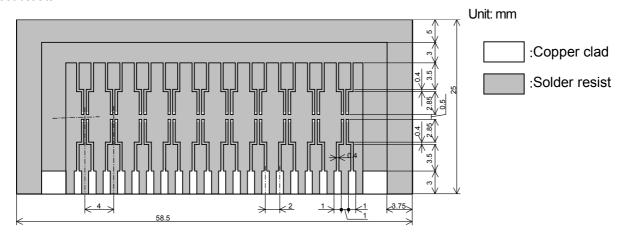
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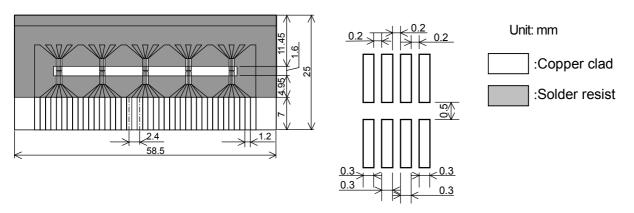
Table-6(5)

| No | Test items | Condition of test (JIS C 5201 - 1) | Performance requirements |
|----|---|--|---|
| 13 | Dimensions (detail) | Sub-clause 4. 4. 3 | As in Sub-clause 5.1 of this specification |
| | Mounting | Sub-clause 4. 31 Substrate material: Epoxide woven glass Test substrate: Figure-6 | ' |
| | Endurance at upper category temperature | Sub-clause 4. 25. 3 Ambient temperature:125°C±2°C Duration: 1000 h Examination at 48 h, 500 h and 1000 h: Visual examination | No visible damage |
| | | Resistance | $\Delta R \le \pm (5\% + 0.1\Omega)$ Chip jumper: 50 m Ω max. |

8. Test substrate



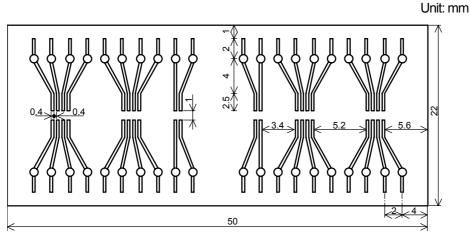
RAC10 2D TEST SUBSTRATE



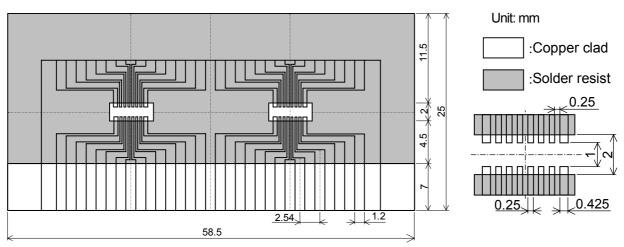
RAC10 4D TEST SUBSTRATE

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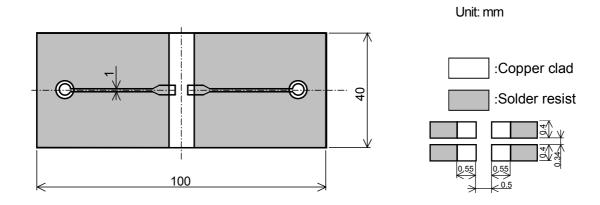


RAC16 4D TEST SUBSTRATE



RAC16 8D TEST SUBSTRATE

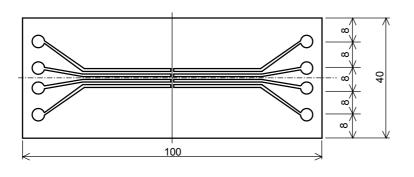
- Remark 1). Material: Epoxide woven glass
 Thickness: 1. 6mm Thickness of copper clad: 0.035mm
 - In the case of connection by connector, the connecting terminals are gold plated.
 However, the plating is not necessary when the connection is made by soldering.
 Figure–6

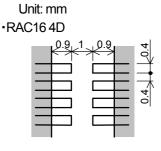


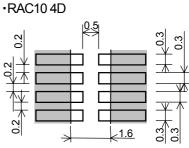
RAC10 2D BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE

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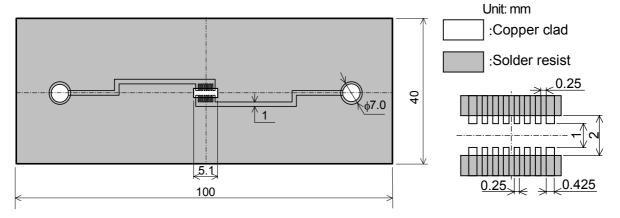
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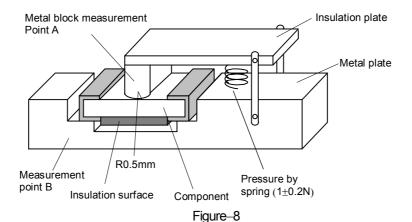


RAC10 4D, 16 4D BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE



RAC16 8D TERMINAL STRENGTH TEST SUBSTRATE

Remark 1). Material: Epoxide woven glass
Thickness: 1.6mm Thickness of copper clad: 0.035mm
Figure–7



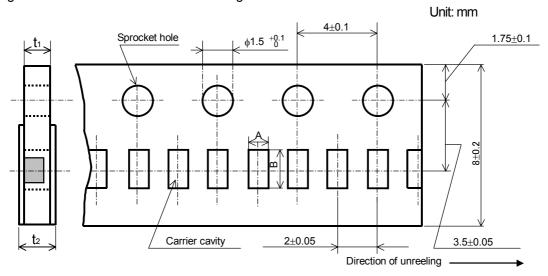
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9. Taping

- 9.1 Applicable documents JIS C 0806-3: 1999, EIAJ ET-7200B: 2003
- 9.2 Taping dimensions
- 9.2.1 RAC10 2D, RAC10 4D (Paper taping, 8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-8 and Table-7.



Figure–9 Table–7 Unit: mm

A B t_1 t_2 1.15 $^{+0.05}_{-0.10}$ 1.15 $^{+0.05}_{-0.10}$ 0.4 $^{+0.05}_{-0.10}$ 1.2±0.1 2.2±0.1 0.4±0.1 0.5max.

9.2.2 RAC16 4D, RAC16 8D (Paper taping, 8mm width, 4mm pitches)

Style

RAC102D

RAC104D

Taping dimensions shall be in accordance with Figure-10 and Table-8.

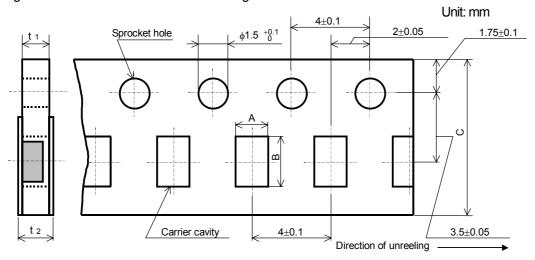
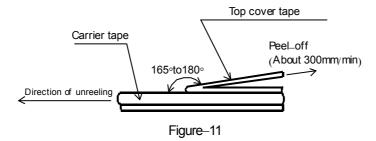


Figure-10 Table-8 Unit: mm С t₁ Style Α В t₂ RAC164D 1.9±0.15 3.6±0.2 8.0±0.2 0.6±0.1 0.8max. RAC168D 1.9±0.15 4.1±0.15 8.0 ± 0.3

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- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following Figure-11.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.
 The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.
- 9). The direction of resistor shall be taped as Figure-12.



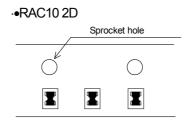


Figure-12

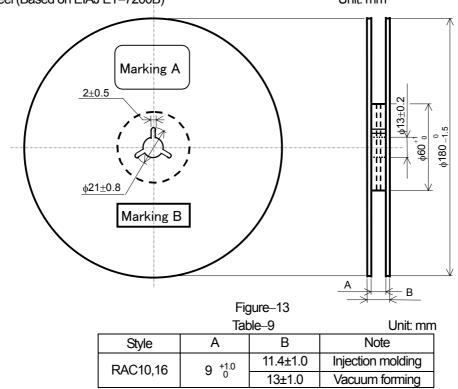
Title: FIXED CHIP RESISTOR NETWORKS; RECTANGULAR TYPE

RAC10 2D, RAC10 4D, RAC16 4D, RAC16 8D Page: 15/15

9.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure–13 and Table–9. Plastic reel (Based on EIAJ ET–7200B)

Unit: mm



Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

9.4 Leader and trailer tape.

(Example)

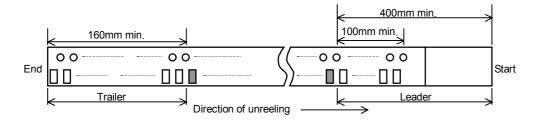


Figure-14

10. Marking on package

The label of a minimum package shall be legibly marked with follows.

10.1 Marking A

- (1) Classification (Style, Rated resistance, Tolerance on rated resistance, Terminal style, Packaging form)
- (2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others
- 10.2 Marking B (KAMAYA Control label)